2010-03-16

!! 1st UPDATE !!

OS-PCN-2010-016-A1

Dear Customer,

There are changes compared to previous OS-PCN-2010-016-A - see next page.

"Introduction of Ni underlayer for Infrared PowerTOPLED and TOPLED with lens"

Important information for your attention:

- Please respond to this PCN by indicating your decision on the approval form, sign it and return to your sales partner before 20th April 2010.
- OSRAM aligns with the widely-recognized JEDEC STANDARD "JESD46-B", which stipulates: "Lack of acknowledgement of the PCN within 30 days constitutes acceptance of the change".

Your prompt reply will help OSRAM OS to assure a smooth and well executed transition. If OSRAM does not hear from your side by the due date, we will assume your full acceptance to this proposed change and its implementation.

Your attention and response to this matter is greatly appreciated.



2010-03-16

!! 1st UPDATE !!

OS-PCN-2010-016-A1

- Updated Information in ITALIC BLUE TYPE
- Original PCN see PCN N° OS-PCN-2010-016-A dated 15th February 2010

SUBJECT OF CHANGE: Introduction of Ni underlayer for Infrared PowerTOPLED

and TOPLED with lens

PRODUCTS AFFECTED: Please refer to:

1 cip OS-PCN-2010-016-A1 Product List

REASON OF CHANGE: In order to achieve further improvement of product

> robustness a diffusion barrier layer will be integrated between the leadframe base metal and final silver finish in

combination with an increased die attach cure

temperature.

There are no changes at the physical outlines of the IRED / Detector. The solder terminals will remain unchanged.

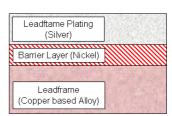
DESCRIPTION OF CHANGE:

Leadframe Plating

Current



New



Glue Curing Temperature

Glue curing temperature will be increased by 20°C

Please take note:

For some of the products affected by this PCN (PowerTopled with Lens), another product change notification (OS-PCN-2009-021-A) was distributed to customers in parallel.

PCN-samples ordered via OS-PCN-2010-016-A1 will also include the changes explained in OS-PCN-2009-021-A1. See also 1 cip OS-PCN-2010-016-A1 Product List for

details.

PRODUCT IDENTIFICATION: Date code



2010-03-16

!! 1st UPDATE !!

OS-PCN-2010-016-A1

OS-PCN-2010-016-A OS-PCN-2010-016-A1 TIME SCHEDULE:

March 2010 **April 2010** Qualification report:

see 2_cip_OS-PCN-2010-016-A1

see 2_cip_OS-PCN-2010-016-A1

Earliest June 2010

Samples available: March 2010

see 1_cip_OS-PCN-2010-016-

A_Product_List

Production release: March 2010 **July 2010**

May 2010*

Start of delivery: (*or earlier if released by

customers)

ASSESSMENT:

For changes according to OS-PCN-2010-016-A1 (Ni-Underlayer

introduction):

No impact on product reliability nor on electrical or optical parameters.

July 2010*

No changes in data sheet

For changes according to OS-PCN-2009-021-A1 (Chip-Improvement) There will be changes in the respective data sheets. For further details,

please refer to respective OS-PCN-2009-021-A1

DOCUMENTATION: 1_cip_OS-PCN-2010-016-A1_Product_List



2010-03-16

!! 1st UPDATE!!

OS-PCN-2010-016-A1

Customer Approval Form

Introduction of Ni underlayer for Infrared PowerTOPLED and TOPLED with lens

Please list product(s) affected in your application(s):
Please check the appropriate box below:
☐ We agree with the proposed change and accept start of shipment upon availability of new version.
☐ We have objections:
☐ We need more information:
☐ We need the following samples:
Sender: Company:
Address/Location:
Signature Date
Please return to your Sales partner: Name:
Address/Location:
TELEPHONE FAX E-MAIL



OS-PCN-2010-016-A1 Product list Introduction of Ni underlayer for Infrared PowerTOPLED and TOPLED with lens

Products affected:

Device

TOPLED with Lens

SFH 4209 discontinued product

SFH 4246 will be discontinued soon

SFH 4289 will be discontinued soon

SFH 3219

PowerTOPLED with Lens

SFH 4248

SFH 4249

SFH 4258

SFH 4259

Legend:

Samples available earliest June 2010	
Other samples on request	

Product names in red, bold letters announced in OS-PCN-2009-21-A1.

Please take note.

